

Dual N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A)	Q _g (TYP.)
30	0.540 at V _{GS} = 4.5 V	0.5	0.72 nC
	0.600 at V _{GS} = 2.5 V	0.2	
	0.700 at V _{GS} = 1.8 V	0.2	
	1.100 at V _{GS} = 1.5 V	0.05	

FEATURES

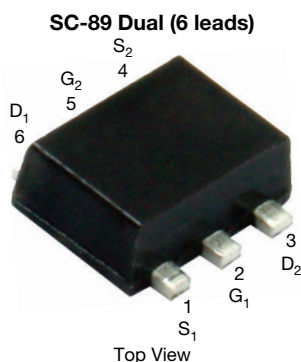
- TrenchFET® Power MOSFET
- 100 % R_g tested
- Gate-source ESD protected: 1000 V
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

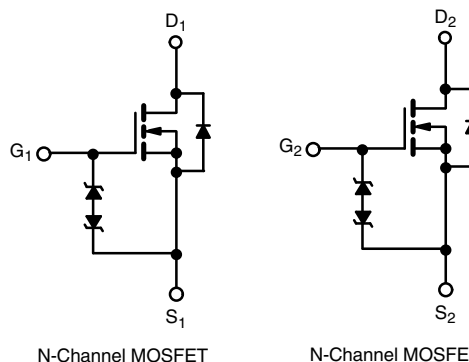
- Load switch
- High speed switching
- DC/DC converters / boost converters
- For smart phones, tablet PCs and mobile computing



Marking Code: B

Ordering Information:

Si1036X-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 8	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	0.61 ^{a,b}	A
	T _A = 70 °C	0.49 ^{a,b}	
Pulsed Drain Current (t = 100 μs)	I _{DM}	2	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S 0.18 ^{a,b}	A
Maximum Power Dissipation ^a	T _A = 25 °C	P _D 0.22 ^{a,b}	W
	T _A = 70 °C	0.14 ^{a,b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient ^b	R _{thJA}	t ≤ 5 s	470	°C/W
		Steady State	560	

Notes

a. Surface mounted on 1" x 1" FR4 board.

b. t = 5 s.

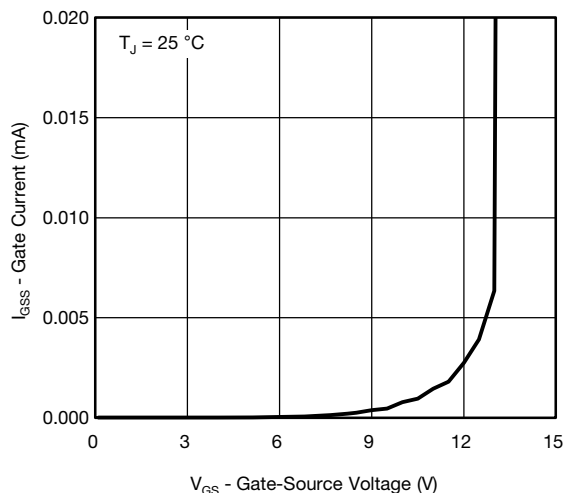
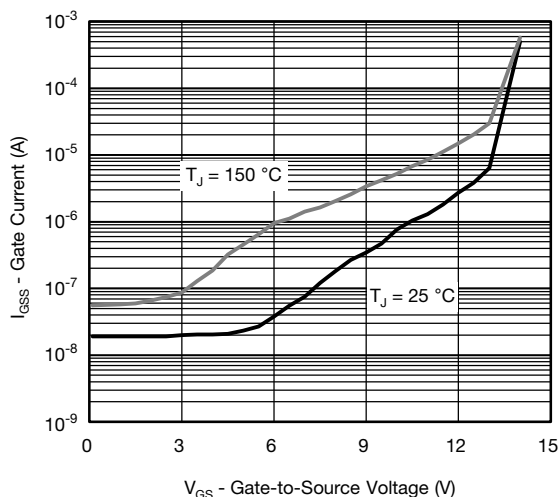
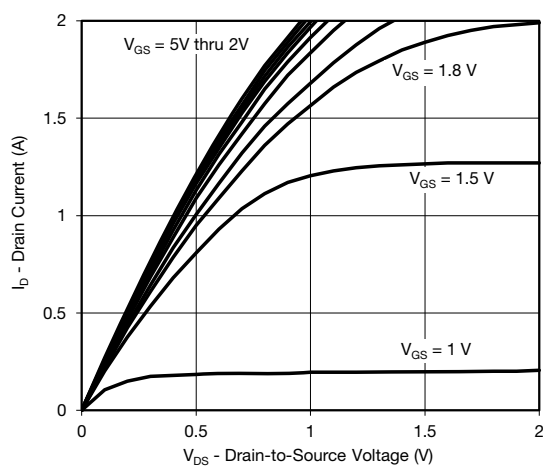
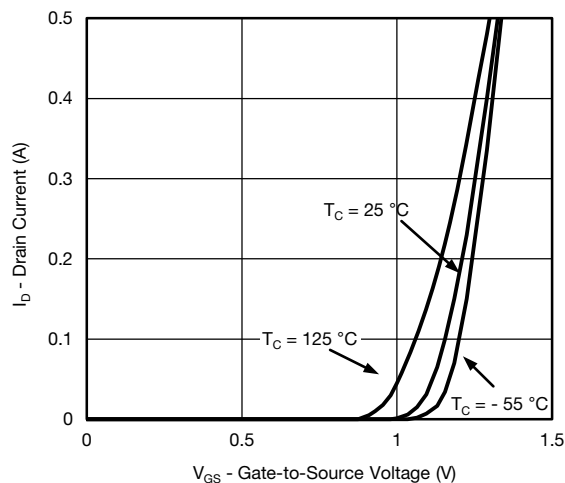
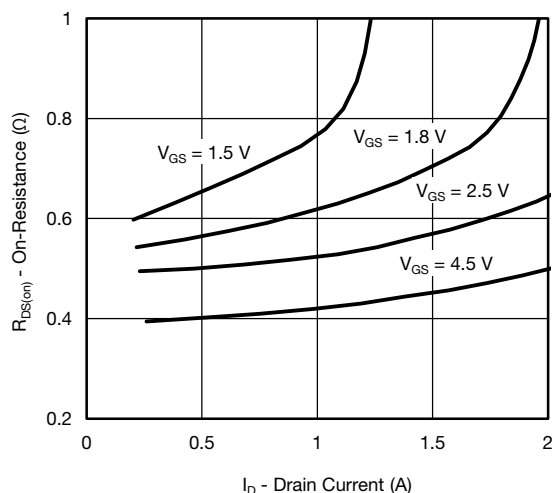
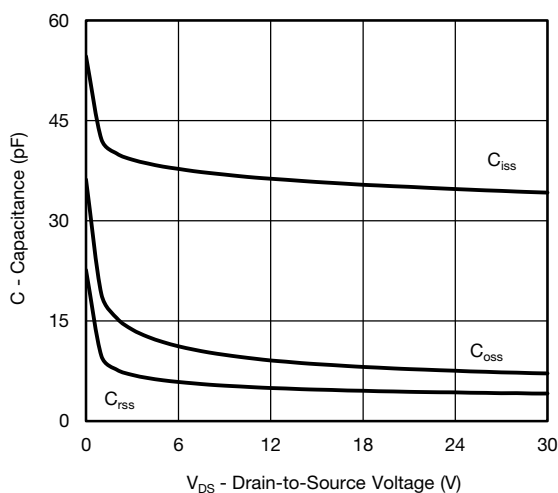


SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30	-	-	V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA	-	29	-	mV/°C	
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J		-	-1.8	-		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.4	-	1	V	
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 8 V	-	-	± 30	μA	
		V _{DS} = 0 V, V _{GS} = ± 4.5 V	-	-	± 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	-	-	1		
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 85 °C	-	-	3		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = ≥ 5 V, V _{GS} = 4.5 V	2	-	-	A	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 0.5 A	-	0.450	0.540	Ω	
		V _{GS} = 2.5 V, I _D = 0.2 A	-	0.500	0.600		
		V _{GS} = 1.8 V, I _D = 0.2 A	-	0.560	0.700		
		V _{GS} = 1.5 V, I _D = 0.05 A	-	0.647	1.100		
Forward Transconductance	g _{fs}	V _{DS} = 15 V, I _D = 0.5 A	-	7.5	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	36	-	pF	
Output Capacitance	C _{oss}		-	9	-		
Reverse Transfer Capacitance	C _{rss}		-	5	-		
Total Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 8 V, I _D = 0.5 A	-	1.2	2	nC	
		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 0.5 A	-	0.72	1.2		
			-	0.1	-		
			-	0.16	-		
Gate-Source Charge	Q _{gs}						
Gate-Drain Charge	Q _{gd}						
Gate Resistance	R _g	f = 1 MHz	2.4	12.2	24.4	Ω	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 15 V, R _L = 37.5 Ω I _D ≅ 0.4 A, V _{GEN} = 4.5 V, R _g = 1 Ω	-	6	15	ns	
Rise Time	t _r		-	13	24		
Turn-Off Delay Time	t _{d(off)}		-	20	30		
Fall Time	t _f		-	11	20		
Drain-Source Body Diode Characteristics							
Pulse Diode Forward Current ^a	I _{SM}		-	-	2	A	
Body Diode Voltage	V _{SD}	I _S = 0.5 A	-	0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	I _F = 0.4 A, dI/dt = 100 A/μs	-	8	15	ns	
Body Diode Reverse Recovery Charge	Q _{rr}		-	2	4	nC	
Reverse Recovery Fall Time	t _a		-	4	-	ns	
Reverse Recovery Rise Time	t _b		-	4	-		

Notes

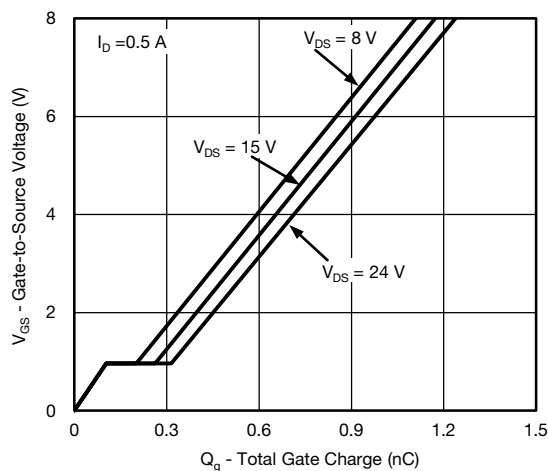
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

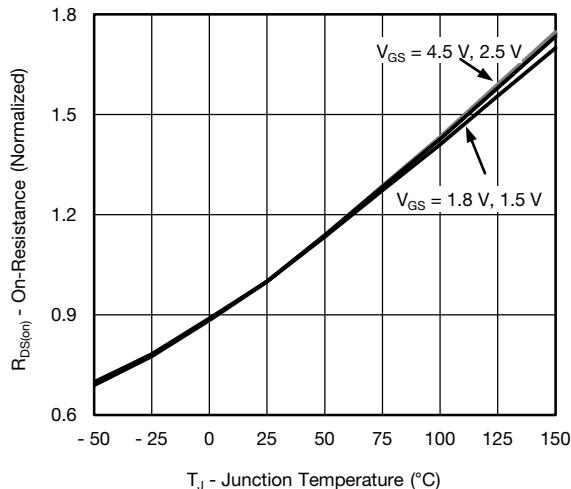
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Gate Current vs. Gate-Source Voltage

Gate Current vs. Gate-Source Voltage

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current

Capacitance



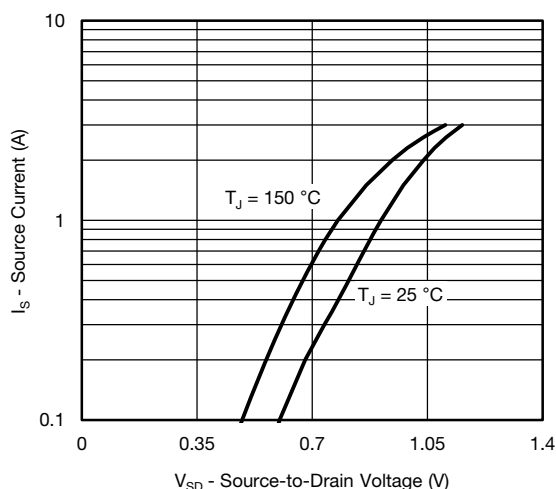
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



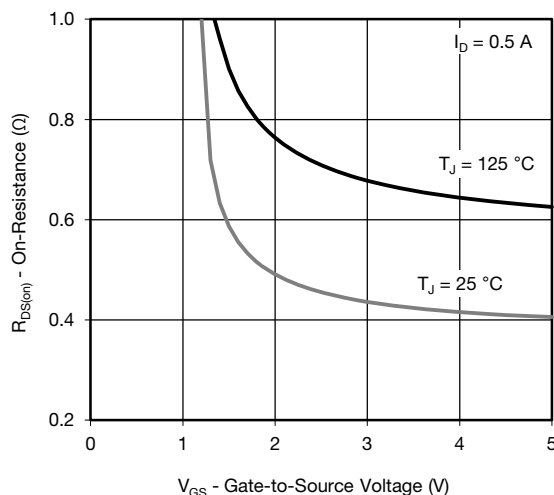
Gate Charge



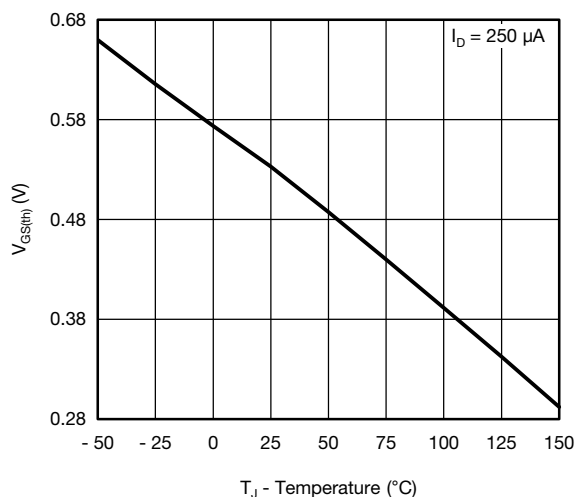
On-Resistance vs. Junction Temperature



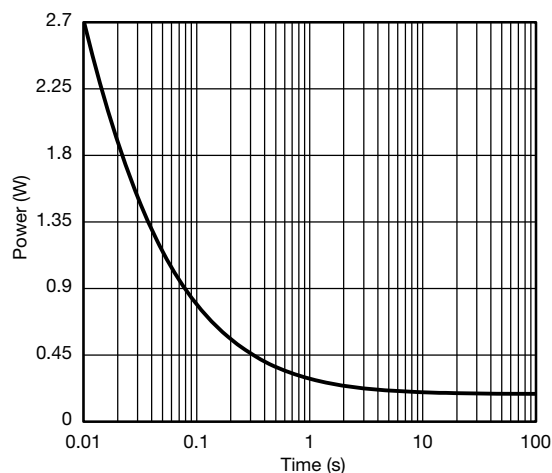
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



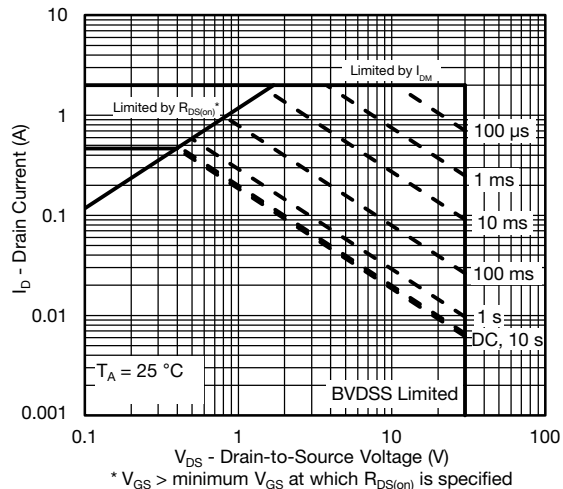
Threshold Voltage



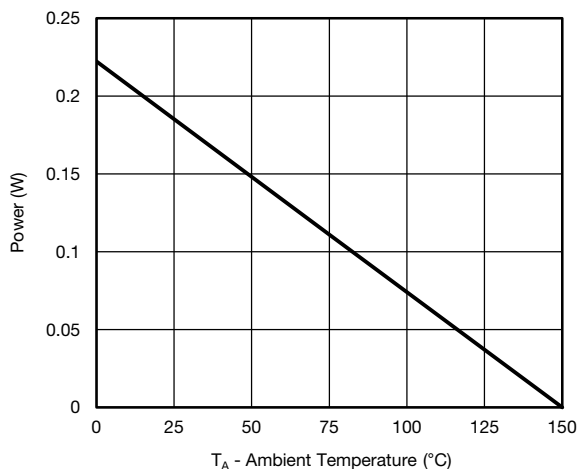
Single Pulse Power, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

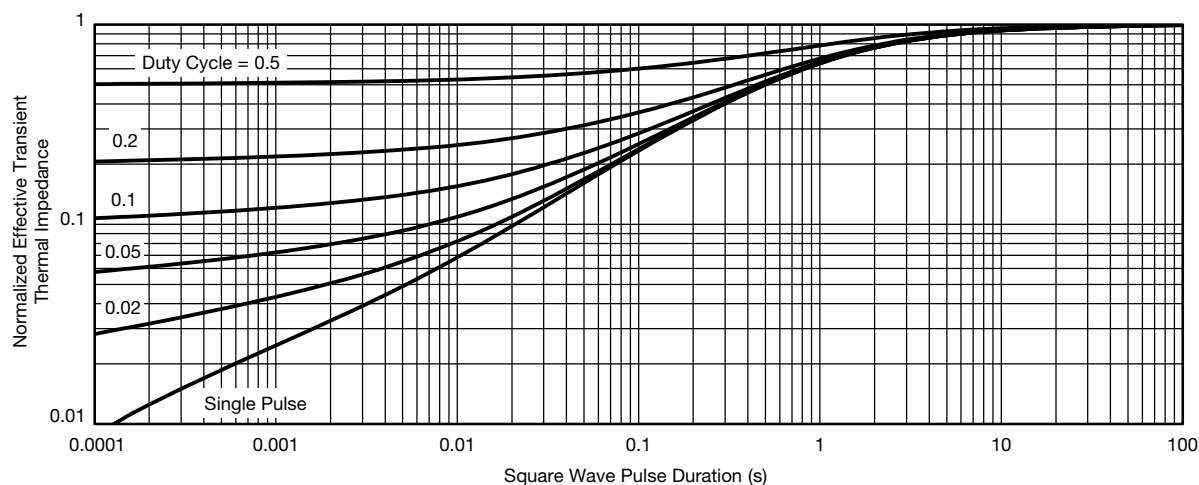


Safe Operating Area, Junction-to-Ambient



Power Derating, Junction-to-Ambient

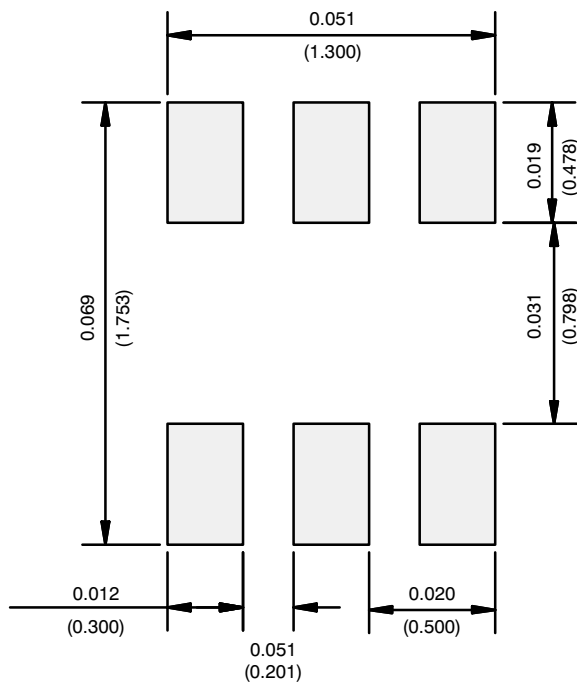
* The power dissipation P_D is based on $T_{J(max)} = 150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient

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RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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